SHARP

Spec No.	DG-125025
Issue	24-May-12

S P E C I F I C A T I O N S

Product Type

ZENIGATA LED

Model No.

GW6BGW**HED

**: 27, 30, 40, 50

*These specifications contain <u>17</u> pages including the cover and appendix. If you have any objections, please contact us before issuing purchasing order.

CUSTOMERS ACCEPTANCE

DATE:

BY:

Reference

PRESENTED

BY:

Dept. General Manager

REVIEWED BY:

PREPARED BY:

Development Department II Lighting Device Division Electronic Components And Devices Group SHARP CORPORATION

Model No. **GW6BGW**HED**



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• When using the products covered herein, please observe the conditions written herein and the precautions outlined in the following paragraphs. In no event shall the company be liable for any damages resulting form failure to strictly adhere to these conditions and precautions.

(1) Please do verify the validity of this part after assembling it in customer's products, when customer wants to make catalogue and instruction manual based on the specification sheet of this part.

(2) The products covered herein are designed and manufactured for the following application areas. When using the products covered herein for the equipment listed in paragraph (3), even for the following application areas, be sure to observe the precautions given in Paragraph (3). Never use the products for the equipment listed in Paragraph (4).

- \cdot Office electronics
- ·Instrumentation and measuring equipment
- Machine tools
- Audiovisual equipment
- Home appliances
- · Communication equipment other than for trunk lines
- (3) These contemplating using the products covered herein for the following

equipment which demands high reliability, should first contact a sales representative of the company and then accept responsibility for incorporating into the design fail-safe operation, redundancy, and other appropriate measures for ensuring reliability and safety of the equipment and the overall system.

·Control and safety devices for airplanes, trains, automobiles, and other

- transportation equipment
- · Mainframe computers
- · traffic control systems
- ·Gas leak detectors and automatic cutoff devices
- ·Rescue and security equipment
- ·Other safety devices and safety equipment, etc.

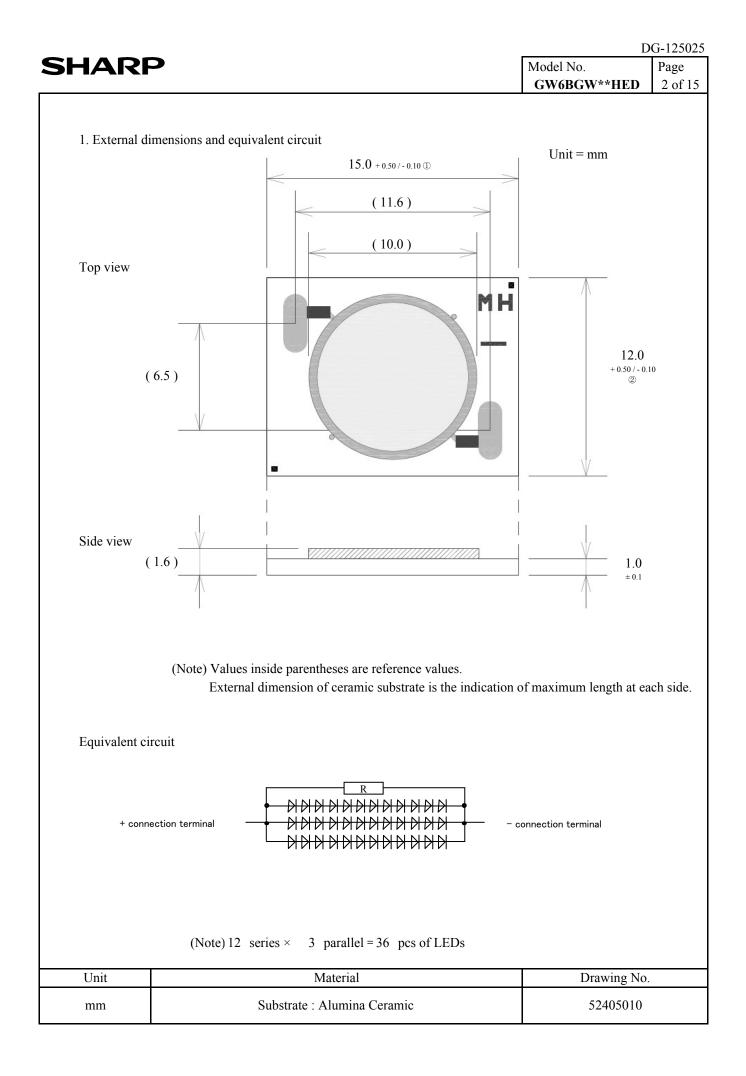
(4) Do not use the products covered herein for the following equipment which

demands extremely high performance in terms of functionality, reliability, or accuracy.

- ·Aerospace equipment
- ·Communications equipment for trunk lines
- ·Control equipment for the nuclear power industry
- ·Medical equipment related to life support, etc.
- (5) please direct all queries and comments regarding the interpretation of the above four Paragraphs to a sales representative of the company.

 Please direct all queries regarding the products covered herein to a sales representative of the company.

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7. Precautions Refer to Page 13 - 15.



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3. Ratings and characteristics

3-1. Absolute maximum ratings

Item	Symbol	Rating	Unit
Power Dissipation *1,4	Р	15.4	W
Forward Current *1,4	I _F	390	mA
Reverse Voltage *2,4	V _R	-15	V
Operating Temperature *3	T _{opr}	- 30 ~ + 100	°C
Storage Temperature	T _{stg}	<i>-</i> 40 ∼ + 100	°C

*1 Power dissipation and forward current are the value when the module temperature is set lower than the rating by using an adequate heat sink.

*2 Voltage resistible at initial connection error

(Not dealing with the possibility of always-on reverse voltage.)

*3 Case temperature Tc (Refer to measuring point for case temperature in the next page.) Refer to "Derating curve" in the next page as for operating current.

*4 T_c = 25 $^{\circ}$ C

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3-2. Electro-optical characteristics

	tro optical characteristics					(T _c	= 90 °C
**	Item	Symbol	Condition	MIN.	TYP.	MAX.	Unit
common	Forward Voltage *5	V _F	$I_F = 240 \text{ mA}$	31.6	(36.0)	39.6	V
27	Luminous Flux *6	Φ		535	(615)	-	lm
	Olympic the Constitution *7	X		-	(0.460 4)	-	-
	Chromaticity Coordinates *7	у	$I_F = 240 \text{ mA}$	-	(0.415 0)	-	-
	Color Temperature	-		-	(2 700)	-	Κ
	General Color Rendering Index *8	Ra		90	(93)	-	-
	Luminous Flux *6	Φ		560	(645)	-	lm
30	Chromaticity Coordinates *7	x		-	(0.437 5)	-	-
	Chromaticity Coordinates • 7	у	$I_F = 240 \text{ mA}$	-	(0.410 0)	-	-
	Color Temperature	-		-	(3 000)	-	Κ
	General Color Rendering Index *8	Ra		90	(93)	-	-
	Luminous Flux *6	Φ		580	(670)	-	lm
	Chromaticity Coordinates *7	x		-	(0.384 6)	-	-
40	Chromaticity Coordinates • 7	у	$I_F = 240 \text{ mA}$	-	(0.384 6)	-	-
	Color Temperature	-		-	(4 000)	-	Κ
	General Color Rendering Index *8	Ra		90	(92)	-	-
	Luminous Flux *6	Φ		600	(690)	-	lm
	Chromaticity Coordinates *7	x		-	(0.347 6)	-	-
50	Chromaticity Coordinates ' /	у	$I_F = 240 \text{ mA}$	-	(0.360 6)	-	-
	Color Temperature	-]	-	(5 000)	-	Κ
	General Color Rendering Index *8	Ra		87	(90)	-	-

(Note) Values inside parentheses are shown for reference purpose only.

- *5 (After 20 ms drive, Measurement tolerance: ± 3 %)
- *6 Monitored by Sharp's 8 inch integrating sphere and Otsuka electronics MCPD-LE3400 (After 20 ms drive, Measurement tolerance: ± 10 %)
- *7 Monitored by Sharp's 8 inch integrating sphere and Otsuka electronics MCPD-LE3400 (After 20 ms drive, Measurement tolerance: ± 0.005)
- *8 Monitored by Sharp's 8 inch integrating sphere and Otsuka electronics MCPD-LE3400 (After 20 ms drive, Measurement tolerance: ± 2)

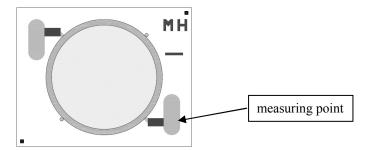
		l
ARF		Model No. GW6BGW**HED
-3. Derating	g curve	
	Forward Current Derating Curve	
450 400		
¥ 350		
[^I		
1 250 200		
gr 150		
150 Horward		
$\begin{bmatrix} -50\\0 \end{bmatrix}$		
	30 -20 -10 0 10 20 30 40 50 60 70 80	90 100 110
	Case Temperature T_c [°C]	

(Note) To keep the case temperature lower than the rating, enough heat-radiation performance needs to be secured by using an adequate heat sink.

For soldering connection, please evaluate in your circumstance to make sure soldering reliability. (Above derating curve is specified to LED device, not for soldering connection) And please consider to avoid physical stress between wire and substrate, and some protection like silicon bond on top of soldered wire is recommended.

Please ensure the maintenance of heat radiation not to exceed case temperature over the rating in operation.

(Measuring point for case temperature)



4. Reliability

The reliability of products shall be satisfied with items listed below.

4-1.7	Test items and test condit	ions	Co	nfidence le	vel: 90 %
No.	Test item	Test conditions	Samples	Defective	LTPD
			n	С	(%)
1	Temperature Cycle	- 40 °C(30 min) \sim + 100 °C(30 min), 100 cycles			
			11	0	20
2	Temperature Humidity	$T_{stg} = +60$ °C, RH = 90 %, Time = 1000 h			
	Storage		11	0	20
3	High Temperature	T_{stg} = + 100°C, Time = 1000 h			
	Storage		11	0	20
4	Low Temperature	$T_{stg} = -40 \text{ °C}, \text{ Time} = 1000 \text{ h}$			
	Storage		11	0	20
5	Steady State Operating	$T_c = 60 \ ^{\circ}C$, $I_F = 240 \ mA$, Time = 1000 h			
	Life		11	0	20
6	Shock	Acceleration: 15000 m/s^2 , Pulse width: 0.5 ms			
		Direction: 3 directions (X, Y and Z)			
		3 trials in each direction	5	0	50
7	Vibration	Frequency: 100 to 2000 Hz for 4 minutes per trial			
		Acceleration: 200 m/s ²			
		Direction: 3 directions (X, Y and Z)			
		4 trials in each direction	5	0	50

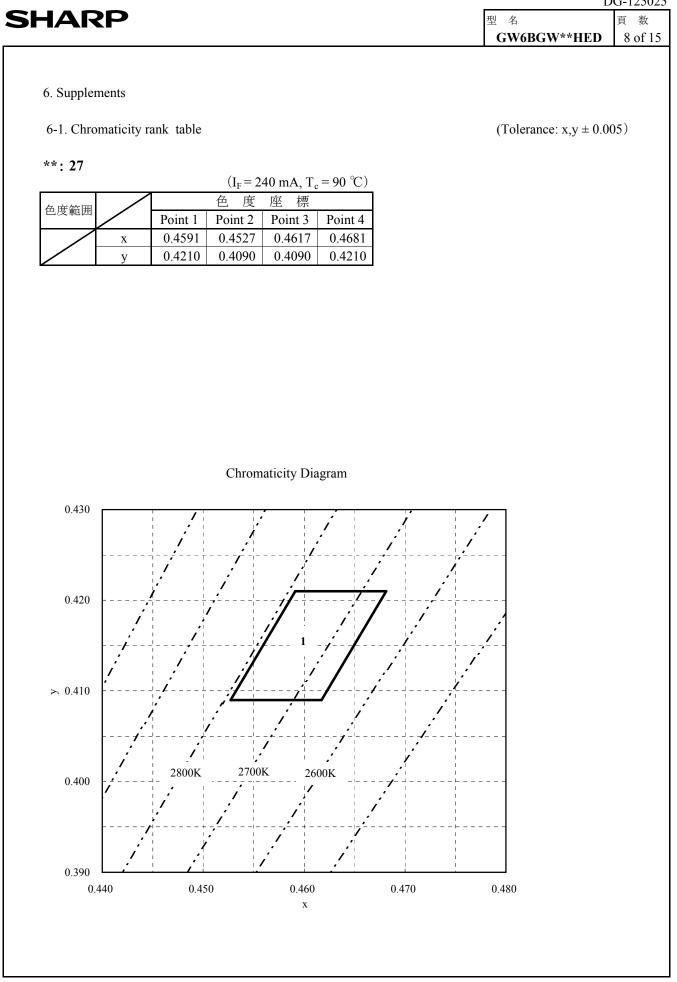
4-2. Failure criteria

	411410 01100114		
No.	Parameter	Symbol	Failure criteria
1	Forward Voltage	V _F	$V_F > Initial value \times 1.1$
2	Luminous Flux	Φ	$\Phi \le$ Initial value $\times 0.7$

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			GW6BGW**H	IED	7 o
5. Quali	ity level				
5-1. Ap	oplied standard				
-	2859-1				
5 2 5	mpling inspecti	ion.			
	1 0 1	mpling plan, level S-4.			
11.51	ingle normal su	implining plan, level 6 1.			
5-3. Ins	spection items a	and defect criteria			
No.	Item	Defect criteria	Classification	AQL	,
	Item No radiation		Classification Major defect	AQL 0.1	_
1 N		Defect criteria	Major		<u>,</u>
1 N 2 E	No radiation	Defect criteria No light emitting	Major		<u>,</u>
1 N 2 E	No radiation Electro-optical	Defect criteria No light emitting Not conforming to the specification	Major		5
1 N 2 E 3 E	No radiation Electro-optical characteristics	Defect criteria No light emitting Not conforming to the specification (Forward voltage, Luminous flux and Chromaticity)	Major		<u>,</u>
1 N 2 E c 3 E d	No radiation Electro-optical characteristics External	Defect criteria No light emitting Not conforming to the specification (Forward voltage, Luminous flux and Chromaticity) Not conforming to the specified dimensions	Major		<u></u>
1 N 2 E c 3 E d	No radiation Electro-optical characteristics External limensions	Defect criteria No light emitting Not conforming to the specification (Forward voltage, Luminous flux and Chromaticity) Not conforming to the specified dimensions (External dimensions of ① and ② shown in Page 2)	Major defect		<u>,</u>
1 N 2 E c 3 E d	No radiation Electro-optical characteristics External limensions	Defect criteria No light emitting Not conforming to the specification (Forward voltage, Luminous flux and Chromaticity) Not conforming to the specified dimensions (External dimensions of ① and ② shown in Page 2) Nonconformity observed in product appearance is determined	Major defect	0.1	
1 N 2 E c 3 E d	No radiation Electro-optical characteristics External limensions	Defect criteria No light emitting Not conforming to the specification (Forward voltage, Luminous flux and Chromaticity) Not conforming to the specified dimensions (External dimensions of ① and ② shown in Page 2) Nonconformity observed in product appearance is determined as defective only when electro-optical characteristics is affected by.	Major defect	0.1	<u>,</u>
1 N 2 E c 3 E d	No radiation Electro-optical characteristics External limensions	Defect criteria No light emitting Not conforming to the specification (Forward voltage, Luminous flux and Chromaticity) Not conforming to the specified dimensions (External dimensions of ① and ② shown in Page 2) Nonconformity observed in product appearance is determined as defective only when electro-optical characteristics is affected by. <if above="" any="" arises="" criterion="" mentioned="" of="" question="" regardless=""></if>	Major defect	0.1	<u></u>
1 N 2 E c 3 E d	No radiation Electro-optical characteristics External limensions	Defect criteria No light emitting Not conforming to the specification (Forward voltage, Luminous flux and Chromaticity) Not conforming to the specified dimensions (External dimensions of ① and ② shown in Page 2) Nonconformity observed in product appearance is determined as defective only when electro-optical characteristics is affected by. <if above="" any="" arises="" criterion="" mentioned="" of="" question="" regardless=""> ■ Foreign material, scratch, or bubble at emitting area: 0.8 mm φ</if>	Major defect	0.1	<u>,</u>

 Substrate burr on edge: Over dimension tolerance

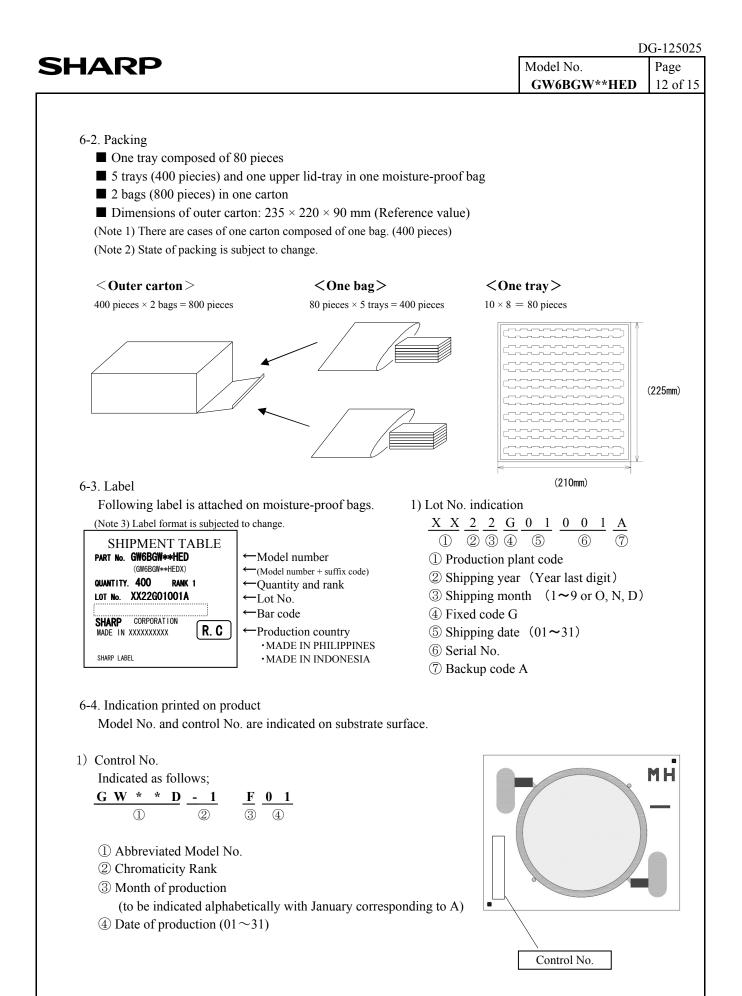
 (Note) Products with removable foreign material attached on is not determined to be defective.



IARP				型 名 GV	^当 V6BGW**HED	頁 9
						7
						\
				(To	blerance: $x, y \pm 0.0$	005)
**: 30						
. 30	$(I_{\rm E} = 24)$	$40 \text{ mA}, \text{T}_{c} = 90 ^{\circ}\text{C})$				
	1 色度	座標]			
色度範囲	Point 1 Point 2	Point 3 Point 4				
X	0.4362 0.4298	0.4388 0.4452	=			
у	0.4160 0.4040	0.4040 0.4160				
	Chrom	aticity Diagram				
	Chrom	aticity Diagram				
	Chrom	aticity Diagram				
0.425	Chrom	aticity Diagram				
0.425	Chrom	aticity Diagram				
0.425	Chrom	aticity Diagram				
	Chrom	aticity Diagram				
0.425	Chrom	aticity Diagram				
	Chrom	aticity Diagram				
	Chrom	aticity Diagram				
	Chrom	aticity Diagram				
	Chrom	aticity Diagram				
0.415	Chrom	aticity Diagram				
0.415	Chrom	aticity Diagram				
0.415						
0.415 > 0.405	Chrom	aticity Diagram				
0.415						
0.415 > 0.405						
0.415 > 0.405						
0.415 0.415 0.405 0.395						
0.415 0.415 0.405 0.395 0.395 0.385	3100K	1 1 3000K 2900K	0.445		5	
0.415 0.415 0.405 0.395		1 3000K 2900K 0.435	0.445	0.45	5	
0.415 0.415 0.405 0.395 0.395 0.385	3100K	1 1 3000K 2900K	0.445	0.45	5	

ARP				푄	型名 GW6BGW*	**HED
					3 11 0 0 11	
					(Tolerance: :	$x,y \pm 0.003$
*: 40	/I	2 40 A T = 00	\sim			
	(I _F = 色度	240 mA, T _c = 90 E 座 標	0			
度範囲	Point 1 Point 2		nt 4			
x	0.3833 0.3769		923			
y y	0.3906 0.3786		906			
	Chro	omaticity Diagram	1			
	Chro	omaticity Diagram	1			
0.400	Chro	omaticity Diagram	1			
0.400	Chro	omaticity Diagram				
0.400	Chro /	omaticity Diagram				
0.400	Chro	omaticity Diagram				
	Chro	omaticity Diagram				
0.400	Chro	omaticity Diagram				
	Chro					
	Chro	omaticity Diagram				
	Chro	omaticity Diagram				
0.390	Chro	omaticity Diagram				
0.390	Chro	omaticity Diagram				
	Chro					
0.390	Chro	omaticity Diagram				
0.390		1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1			 	
0.390 → 0.380		1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1				
0.390		1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1				
0.390 → 0.380		1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1				
0.390 → 0.380		1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1				
0.390		1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1				
0.390		1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1				
0.390		1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1			0.405	
0.390 > 0.380 0.370 0.360	4000 4100K	1 1 3800K 0K 7 1			0.405	
0.390 > 0.380 0.370 0.360	4000 4100K	0.385			0.405	

HARP		型名 頁数
		GW6BGW**HED 11 of 1
		(Tolerance: $x, y \pm 0.005$)
**: 50	(I - 240 m A T - 00 %)	
色度範囲	(I _F =240 mA, T _c =90 ℃) 色度座標	
	Point 1 Point 2 Point 3 Point 4	
1 <u>x</u> y	0.3463 0.3399 0.3489 0.3553 0.3666 0.3546 0.3546 0.3666	
	······································	
	Chromaticity Diagram	
0.380		
0.370		
0.570		
> 0.360		
0.350	10001/	
0.330	4900K + 5000K	
	5100K /	
0.340		
0.325	0.335 0.345 0.355	0.365
	x	



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7. Precautions		
① Storage conditions		
Please follow the conditions below.		
• Before opened: Temperature 5 \sim 30 °C, Relative humidity less t	han 60 %.	
(Before opened LED should be used within a year)		
• After opened: Temperature 5 \sim 30 °C, Relative humidity less that	an 60 %.	
(Please apply soldering within 1 week)	· · · · · ·	
•After opened LED should be kept in an aluminum moisture proof l	bag with a moisture	
absorbent material (silica gel).Avoid exposing to air with corrosive gas.		
If exposed, electrode surface would be damaged, which may affect	soldering	
	i soldering.	
② Usage conditions		
This product is not designed for the use under any of the following		
Please confirm performance and reliability well enough if you use		ons;
•In a place with a lot of moisture, dew condensation, briny air, and (Cl, H ₂ S, NH ₃ , SO ₂ , NO _X , etc.)	corrosive gas.	
•Under the direct sunlight, outdoor exposure, and in a dusty place.		
• In water, oil, medical fluid, and organic solvent.		
•Please do not use component parts contain sulfur (gasket packing,	adhesive material, etc.).	
③ Heat radiation		
If forward current (I_F) is applied to single-state module at any curre	ent, there is a risk of damaging LEI	J
or emitting smoke. Equip with specified heat radiator, and avoid heat stuffed inside the	modulo	
Equip with specified near radiator, and avoid near stuffed inside the	e module.	
④ Installation Material of board is alumina ceramic. If installed inappropriately, tr	auble of no rediction may occur de	ia ta
board crack or overheat. Please take particular notice for installation		
Refer to the following cautions on installation.	1.	
Apply thermolysis adhesive, adhesive sheet or peculiar connector	or when mounted on heat radiator.	
In case of applying adhesive or adhesive sheet only, check the effective sheet only and the sheet only and the sheet only and the sheet only and the sheet of the		ĩxing.
If LED comes off from heat radiator, unusual temperature rise en	-	-
device deterioration, coming off of solder at leads, and emitting	smoke.	-
• When LED device is mechanically fixed or locked, Please take i	nto consideration regarding the me	ethod of
attachment due to fail from stress.		
Avoid convexly uneven boards.		
Convex board is subject to substrate cracking or debasement of l		
• It is recommended to apply adhesive or adhesive sheet with high	thermal conductivity	
for radiation of heat effectively.		
• Please take care about the influence of color change of adhesive		g term
period, which may affect light output or color due to change of r	effectance from backside.	

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• Do not touch resin part including white resin part on the surface of LED. No light emission may occur due to damage of resin or cutting wire of LE When using tweezers, please handle by ceramic substrate part and avoid to For mounting, please handle by side part of ceramic or the specified area s	ouching resin part.	
 ⑤ Connecting method In case of solder connecting method, follow the conditions mentioned below Use Soldering iron with thermo controller (tip temperature 380 °C), within Secure the solderwettability on whole solder pad and leads. During the soldering process, put the ceramic board on materials whose connot to radiate heat of soldering. Warm up (with using a heated plate) the substrate is recommended before s (preheat condition: 100 °C ~ 150 °C, within 60 sec) Avoid touching a part of resin with soldering iron. This product is not designed for reflow and flow soldering. Avoid such lead arrangement as applying stress to solder-applied area. Please do not detach solder and make re-solder. Please solder evenly on each electrodes. 	1 5 seconds per one place nductivity is poor enough	
 Please prevent flux from touching to resin. 6 Static electricity This product is subject to static electricity, so take measures to cope with it. Install circuit protection device to drive circuit, if necessary. 		
 ⑦ Drive method Any reverse voltage cannot be applied to LEDs when they are in operation Design a circuit so that any flow of reverse or forward voltage can not be ap when they are out of operation. Module is composed of LEDs connected in both series and parallel. Constant voltage power supply runs off more than specified current amount caused by temperature rise. Constant current power supply is recommended to drive. 	plied to LEDs	
 ⑧ Cleaning Avoid cleaning, since silicone resin is eroded by cleaning. ⑨ Color-tone variation Chromaticity of this product is monitored by integrating sphere right after the Chromaticity varies depending on measuring method, light spread condition, Please verify your actual conditions before use. 	-	

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10 Safety

- ·Looking directly at LEDs for a long time may result in hurt your eyes.
- •In case that excess current (over ratings) are supplied to the device, hazardous phenomena including abnormal heat generation, emitting smoke, or catching fire can be caused.
- Take appropriate measures to excess current and voltage.
- In case of solder connecting method, there is a possibility of fatigue failure by heat.
- Please fix the leads in such case to protect from short circuit or leakage of electricity caused by contact.
- Please confirm the safety standards or regulations of application devices.
- •Please careful not to injure your hand by edge of ceramic substrate.

① Other cautions

Guarantee covers the compliance to the quality standards mentioned in the Specifications, however it does not cover the compatibility with application of the end-use, including assembly and usage environment.

In case any quality problems occurred in the application of end-use, details will be separately discussed and determined between the parties hereto.